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	56001 s or copy thereof.
1. Name of conveying party(ics):	Name and address of receiving party(ies):
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	Name: Sony Corporation
Additional name(s) of conveying party(ies) attached? Yes X No	Internal Address:
3. Nature of Conveyance:	S. AAN ZOSKO V.
X Assignment	Street Address: 7-35 Kitashinagawa 6-chome Shinagawa-ku, Tokyo, Japan
Ssignment Nerger	City State ZIP
Security Agreement Change of Name	CityStateZIP
Other	
Execution Date: December 22, 1998	Additional name(s) & address(es) attached?
4. Application number(s) or patent number(s):	
If this document is being filed together with a new application, the execution A. Patent Application No.(s)	B. Patent No.(s)
Additional number	s attached. Yes No
5. Name and address of party to whom correspondence concerning document should be mailed:	6. Total number of applications and patents involved:
Name: Jay II Maioli	
Internal Address: Cooper & Dunham LLP	7. Total fee (37 CFR 3.41):
	Authorized to be charged to deposit account
Street Address 1185 Avenue of the Americas	8. Deposit account number:
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5 Statement and signature.	T USE THIS SPACE
To the best of my knowledge and belief, the foregoing the criginal document. Jay F. Maioli	g information is true and correct and any attached copy is a true copy
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PATENT REEL: 9726 FRAME: 0912

S99P0074US00

Docket Number: 57614
ASSIGNMENT
WHEREAS, I, as a below named inventor, residing at the address stated next to my name, am a sole inventor (only one name is listed below) or a joint inventor (if plural names are listed below) of certain new and useful improvements in
RADL() TRANSMISSION METHOD AND RADIO TRANSMISSION DEVICE
for which application for Leiters Patent of the United States of America was executed by me on the date indicated next to my han and address:
AND WHEREAS, Sony Corporation, a Japanese corporation with offices at 7-35 Kitashinagawa 6-Chom Shinagawa-Ku, Tokyo, Japar (hereinafter referenced as ASSIGNEE) is desirous of acquiring all interest in, to and under said invertic said application disclosing the invention and in, to and under any Letters Patent or similar legal protection which may be grant-therefor in the United States and in any and all foreign countries;
NOW THEREFORE, in consideration of the sum of One Dollar (\$1.00), and other good and valuable consideration the receipt and sufficiency of which are hereby acknowledged, I, as a sole or joint inventor as indicated below, by these presents the nereby assign, sell and transfer unto the said ASSIGNEE, its successors, assigns, and legal representatives, the entire right, title and interest in the said invention, said application, including any divisions and continuations thereof, and in and to any and all Letter Patent of the United States, and countries foreign thereto, which may be granted for said invention, and in and to any and all priority rights and/or convention rights under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States of American adheres, and to any other benefits accruing or to accrue to me with respect to the filling of applications for patents or securing patents in the United States and countries foreign thereto, and I hereby authorize and request the Commissioner of Patents to issue the said United States Letters Patent to said ASSIGNEE, as the assignee of the whole right, title and interest thereto;
And I further agree to execute all necessary or destrable and lawful future documents, including assignments in favor of ASSIGNEE or its designee, as ASSIGNEE or its successors, assigns and legal representatives may from time-to-time present to related without further remuneration, in order to perfect title in said invention, modifications, and improvements in said invention applications and Letters Pat int of the United States and countries foreign thereto;
And I curther agree to properly execute and deliver and without further remuneration, such necessary or desirable and lawter papers for application for fereign patents, for filing subdivisions of said application for patent, and or, for obtaining any reissue of any letters Pater: which may be granted for my aforesaid invention, as the ASSIGNEE thereof shall hereafter require an prepare at its own expense;
And I writher agree that ASSIGNEE will upon its request, be provided promptly with all pertinent facts and document relating to said application, said invention and said Letters Patent and legal equivalents in foreign countries as may be known an accessible to me and will testify as to the same in any interference or litigation related thereto;
And I hereby coverant that no assignment, sale, agreement or encumbrance has been or will be made or entered into which would conflict with this assignment and sale.
And I hereby authorize and request my attorney(s) of record in this application to insert the serial number and filing date of this application in the spaces that follow: Serial Number:
This arrighment executed on the cates indicated below
SH. GERU SUGAYA December 22, 192
SH. GERU SUGAYA Name of first or sole inven or Execution date of U.S. Patent Application
KANAGAWA, JAPAN
Residence of first or sole inventor

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December 21, 992

Date of this assignmen

RECORDED: 01/19/1999

Signature of fir or sole inventor